PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Shun Ming Yuen	01/09/2006

RECEIVING PARTY DATA

Name:	INNOVATION TECHNOLOGY CO., LTD.
Street Address:	370 Kwun Tong Rd., Kwun Tong, Kowloon
Internal Address:	Unit 2301-02, 23/F, Millennium City 3
City:	Hong Kong
State/Country:	CHINA

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	11278024	

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: STD-102

NAME OF SUBMITTER: Tianhua Gu

Total Attachments: 1

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PATENT REEL: 017407 FRAME: 0406

Docket No.: STD-102

ASSIGNMENT

WHEREAS, I/WE:

RECORDED: 04/03/2006

SHUN MING YUEN, residing in Unit 2301-02, 23/F, Millennium City 3, 370 Kwun Tong Road, Kwun Tong, Kowloon, Hong Kong.

have invented certain new and useful improvements in the following:
Bluetooth Earphone
for which a United States patent application therefor has been executed on
INNOVATION TECHNOLOGY CO., LTD. (hereinafter referred to as the Assignee), a body having a place of business at Unit 2301-02, 23/F, Millennium City 3, 370 Kwun Tong Road, Kwun Tong, Kowloon, Hong Kong and corporate powers under the laws of Hong Kong, desires to acquire the entire right, title and interest in said application and invention, and to any United States and foreign patents to be obtained therefor.
NOW THEREFORE, for a valuable consideration, receipt whereof is hereby acknowledged, I/we, the above named, hereby sell, assign, and transfer to Assignee, its successors and assigns, the entire right, title and interest in said application and inventions therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said application, I/we hereby agree that Assignee may apply for foreign Letters Patent on said inventions, and I/we hereby agree to timely execute all papers necessary in connection with said United States and foreign Letters Patent applications when called upon to do so by Assignee.
I/we hereby covenant that I/we have the full and lawful right to convey the entire right, title, and interest herein assigned, and that I/we have not entered and will not enter into any agreement in conflict herewith.
I/we hereby request the Commissioner for Patents to issue any Letters Patent granted upon the inventions set forth in said application to Assignee, its successors and assigns.
\$ 12 M
Date: 2006-01-09
SHUN MING YUEN
State: County:

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